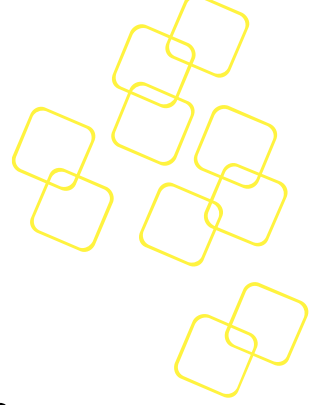


Date: Jan 1st, 2024

Document Version: V1.0



Product EOL Notification

PCN-Q240101

Key Characteristics of the Change:

DDR5 4800 SODIMM&UDIMM&RDIMM Micron A-Die product series phase out.

And last-time-buy date is **Jun 30th, 2024**.

Description of Change to the Customer:

As following Micron IC roadmap, Micron DDR5 4800 1z 2GX8 & 1GX16 A DIE IC chip is going to phase out. Hereby announces the EOL plan for DDR5 4800 series Micron A-Die will transition to Samsung B Die

EOL parts:

- 1) Micron DDR5 4800MT/s A-Die SODIMM
- 2) Micron DDR5 4800MT/s A-Die UDIMM
- 3) Micron DDR5 4800MT/s A-Die RDIMM

Customer Impact of Change and Recommended Action:

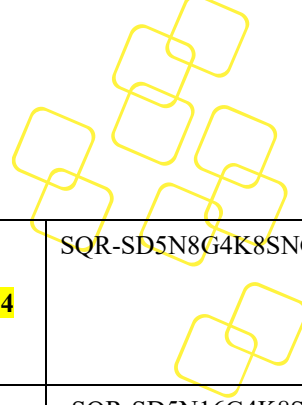
Please determine the remaining demands and provide last-time-buy orders by **Jun 30th, 2024**

Based on the purchase order and quantities that customers provided, the last shipment date is **Aug 30th, 2024**

*For customized P/N, please contact local Sales manager

Product Affected:

Model	EOL Announcement	Last Time Buy (EOL)Date	Last Shipment Date	Replacement
SQR-UD5N8G4K8MNGAB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-UD5N8G4K8SNGBB
SQR-UD5N16G4K8MNAB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-UD5N16G4K8SNBB
SQR-UD5N32G4K8MNAB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-UD5N32G4K8SNBB



SQR-SD5N8G4K8MNGAB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-SD5N8G4K8SNGBB
SQR-SD5N16G4K8MNAB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-SD5N16G4K8SNBB
SQR-SD5N32G4K8MNAB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-SD5N32G4K8SNBB
SQR-RD5N16G4K8MZZB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-RD5N16G4K8SZZB
SQR-RD5N32G4K8MZZB	Jan, 1st, 2024	Jun 30th, 2024	Aug 30th, 2024	SQR-RD5N32G4K8SZZB

*Milestone dates are subject to change based on business and operational conditions.